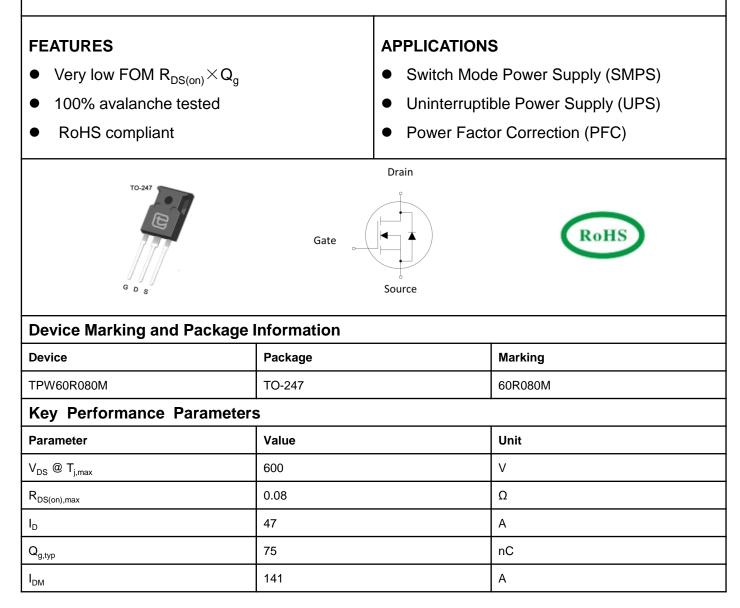


## **600V Super-Junction Power MOSFET**

#### DESCRIPTION

#### 600V super-junction Power MOSFET

Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs, designed according to the SJ principle. The SJ MOSFET is a price-performance optimized product enabling to target cost sensitive applications in Consumer and Lighting markets, designed by Wuxi Unigroup Microelectronics Company.



Absolute Maximum Ratings $T_c = 25^{\circ}C$ , unless otherwise noted					
Parameter		Symbol	Value	Unit	
Drain-Source Voltage (V <sub>GS</sub> = 0V)		V <sub>DSS</sub>	600	V	
Continuous Drain Current	T <sub>C</sub> = 25°C	I <sub>D</sub>	47	А	
	TC = 100°C		28.2		
Pulsed Drain Current (note1)		I <sub>DM</sub>	141	A	
Gate-Source Voltage		V <sub>GSS</sub>	±30	V	
Single Pulse Avalanche Energy (note2)		E <sub>AS</sub>	1160	mJ	
Repetitive Avalanche Energy (note2)		E <sub>AR</sub>	1.76	mJ	
Avalanche Current		I <sub>AR</sub>	8.7	A	
MOSFET dv/dt ruggedness, V <sub>DS</sub> = 0480V		dv/dt	50	V/ns	
Power Dissipation		P <sub>D</sub>	391	W	
Continuous Body Diode Current		۱ <sub>s</sub>	40	A	
Pulsed Diode Forward Current (note1)		I <sub>SM</sub>	141		
Reverse diode dv/dt (note3)		dv/dt	15	V/ns	
Maximum diode commutation speed (note3)		di <sub>f</sub> /dt	500	A/us	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	-55~+150	°C	

Thermal Resistance				
Parameter	Symbol	Value	Unit	
Thermal Resistance, Junction-to-Case	R <sub>thJC</sub>	0.32	℃/W	
Thermal Resistance, Junction-to-Ambient	R <sub>thJA</sub>	62		



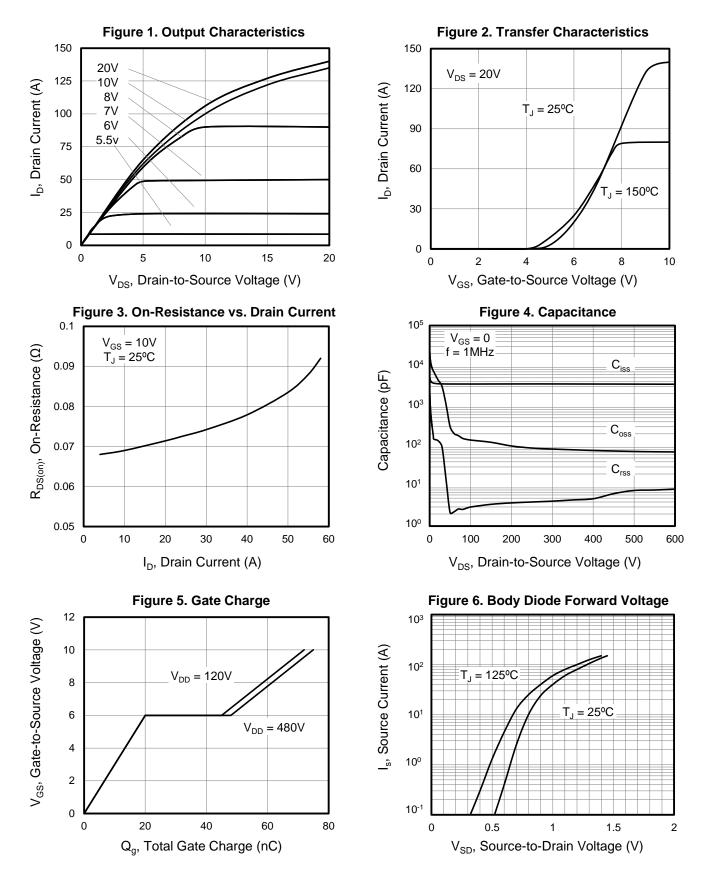
Demonster		To al O and liticana	Value				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		•		•			
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0V, I_{D} = 250\mu A$	600			V	
		$V_{DS} = 600V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μΑ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 600V, V_{GS} = 0V, T_{J} = 150^{\circ}C$			100		
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 30 V$			±100	nA	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.5		4.5	V	
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 24A		0.073	0.08	Ω	
Gate resistance	R <sub>G</sub>	f = 1.0MHz open drain		0.8		Ω	
Dynamic					ı		
Input Capacitance	C <sub>iss</sub>			3488		pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0V,$ $V_{DS} = 100V,$		140			
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0MHz		3			
Total Gate Charge	Qg			75		nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DD} = 480V, I_{D} = 47A, V_{GS} = 10V$		20			
Gate-Drain Charge	Q <sub>gd</sub>			28			
Turn-on Delay Time	t <sub>d(on)</sub>			23			
Turn-on Rise Time	t <sub>r</sub>	V <sub>DD</sub> = 400V, I <sub>D</sub> = 47A,		85.8			
Turn-off Delay Time	t <sub>d(off)</sub>	$R_{\rm G} = 25\Omega$		110.2		ns	
Turn-off Fall Time	t <sub>f</sub>			55.8			
Drain-Source Body Diode Characte	eristics						
Body Diode Voltage	V <sub>SD</sub>	$T_{J} = 25^{o}C, I_{SD} = 47A, V_{GS} = 0V$		0.9	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>			400		ns	
Reverse Recovery Charge	Q <sub>rr</sub>	V <sub>R</sub> = 400V, I <sub>F</sub> = 20A, di <sub>r</sub> /dt = 100A/µs		8		μC	
Peak Reverse Recovery Current	I <sub>rrm</sub>			39.8		А	

#### Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2.  $I_{AS}$  = 8.7A,  $V_{DD}$  = 50V,  $R_{G}$  = 25 $\Omega$ , Starting  $T_{J}$  = 25°C
- 3. Identical low side and high side switch with identical  ${\sf R}_{\sf G}$

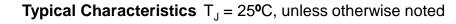


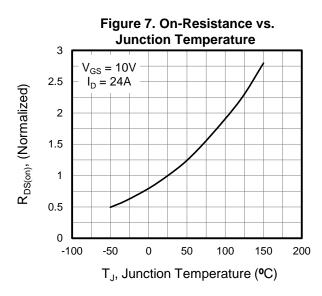
#### **Typical Characteristics** $T_J = 25^{\circ}C$ , unless otherwise noted



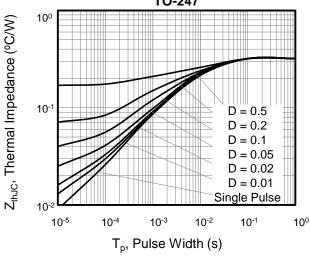
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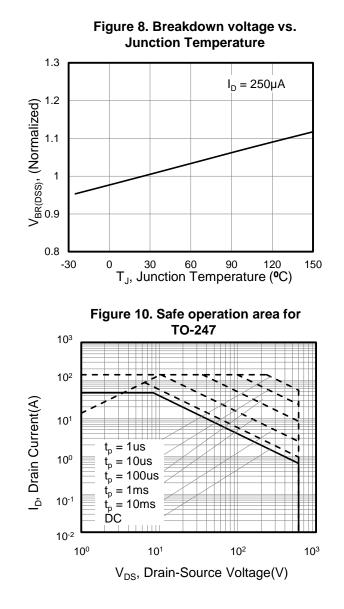
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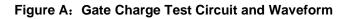












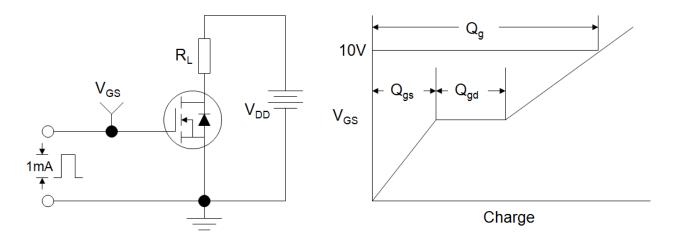


Figure B: Resistive Switching Test Circuit and Waveform

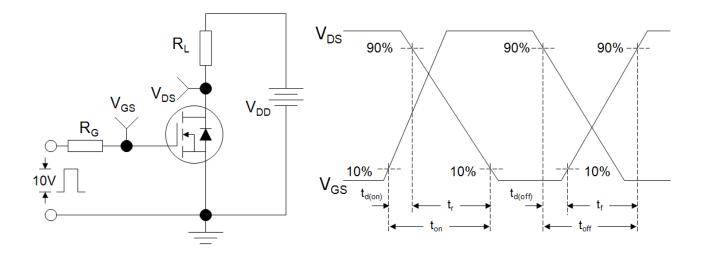
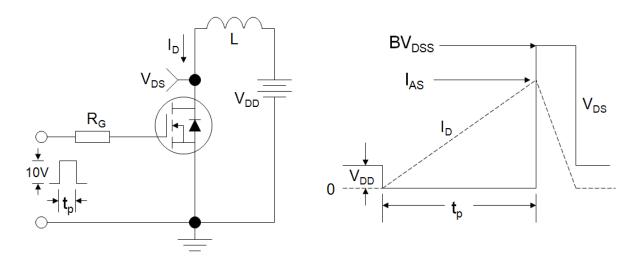


Figure C: Unclamped Inductive Switching Test Circuit and Waveform

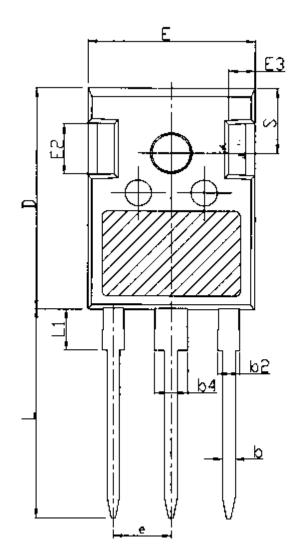


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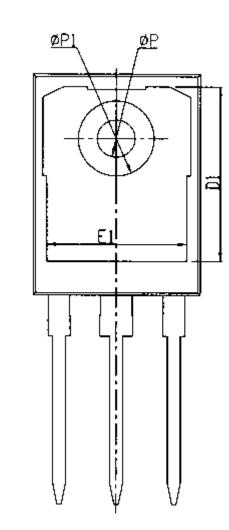
A

<u>A2</u>

<u>A1</u>



t



Unit:mm				
Symbol	Min.	Nom	Max.	
А	4.80	5.00	5.20	
A1	2.21	2.41	2.61	
A2	1.85	2.00	2.15	
b	1.11	1.21	1.36	
b2	1.91	2.01	2.21	
b4	2.91	3.01	3.21	
с	0.51	0.61	0.75	
D	20.70	21.00	21.30	
D1	16.25	16.55	16.85	

Unit:mm					
Symbol	Min. Nom		Max.		
E	15.50	15.80	16.10		
E1	13.00	13.30	13.60		
E2	4.80	5.00	5.20		
E3	2.30	2.50	2.70		
е	5.44BSC				
L	19.62	19.92	20.22		
L1	-	-	4.30		
ΦP	3.40	3.60	3.80		
ΦP1	-	-	7.30		
S	6.15BSC				

<u>C</u>



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